

*Designer's™ Data Sheet*  
**SWITCHMODE™**  
**NPN Bipolar Power Transistor**  
**For Switching Power Supply Applications**

The BUL146/BUL146F have an applications specific state-of-the-art die designed for use in fluorescent electric lamp ballasts to 130 Watts and in Switchmode Power supplies for all types of electronic equipment. These high voltage/high speed transistors offer the following:

- Improved Efficiency Due to Low Base Drive Requirements:
  - High and Flat DC Current Gain
  - Fast Switching
  - No Coil Required in Base Circuit for Turn-Off (No Current Tail)
- Full Characterization at 125°C
- Parametric Distributions are Tight and Consistent Lot-to-Lot
- Two Package Choices: Standard TO-220 or Isolated TO-220
- BUL146F, Isolated Case 221D, is UL Recognized to 3500 VRMS: File #E69369

**MAXIMUM RATINGS**

| Rating   | Symbol                  | BUL146      | BUL146F    | Unit          |
|--|-------------------------|-------------|------------|---------------|
| Collector-Emitter Sustaining Voltage   | $V_{CEO}$               | 400         |            | Vdc           |
| Collector-Emitter Breakdown Voltage  | $V_{CES}$               | 700         |            | Vdc           |
| Emitter-Base Voltage   | $V_{EBO}$               | 9.0         |            | Vdc           |
| Collector Current — Continuous   | $I_C$                   | 6.0         |            | Adc           |
| — Peak(1)  | $I_{CM}$                | 15          |            |               |
| Base Current — Continuous  | $I_B$                   | 4.0         |            | Adc           |
| — Peak(1)  | $I_{BM}$                | 8.0         |            |               |
| RMS Isolated Voltage(2)<br>(for 1 sec, R.H. < 30%,<br>$T_C = 25^\circ\text{C}$ ) | Test No. 1 Per Fig. 22a | —           | 4500       | V             |
|  | Test No. 2 Per Fig. 22b | —           | 3500       |               |
|  | Test No. 3 Per Fig. 22c | —           | 1500       |               |
| Total Device Dissipation<br>Derate above 25°C                                    | $P_D$                   | 100<br>0.8  | 40<br>0.32 | Watts<br>W/°C |
| Operating and Storage Temperature  | $T_J, T_{stg}$          | - 65 to 150 |            | °C            |

**THERMAL CHARACTERISTICS**

| Rating   | Symbol          | BUL44 | BUL44F | Unit |
|--|-----------------|-------|--------|------|
| Thermal Resistance — Junction to Case  | $R_{\theta JC}$ | 1.25  | 3.125  | °C/W |
| — Junction to Ambient  | $R_{\theta JA}$ | 62.5  | 62.5   |      |
| Maximum Lead Temperature for Soldering<br>Purposes: 1/8" from Case for 5 Seconds | $T_L$           | 260   |        | °C   |

**ELECTRICAL CHARACTERISTICS** ( $T_C = 25^\circ\text{C}$  unless otherwise noted)

| Characteristic | Symbol | Min | Typ | Max | Unit |
|----------------|--------|-----|-----|-----|------|
|----------------|--------|-----|-----|-----|------|

**OFF CHARACTERISTICS**

|   |                |     |   |     |                 |
|---|----------------|-----|---|-----|-----------------|
| Collector-Emitter Sustaining Voltage ( $I_C = 100\text{ mA}, L = 25\text{ mH}$ )  | $V_{CEO(sus)}$ | 400 | — | —   | Vdc             |
| Collector Cutoff Current ( $V_{CE} = \text{Rated } V_{CEO}, I_B = 0$ )  | $I_{CEO}$      | —   | — | 100 | $\mu\text{Adc}$ |
| Collector Cutoff Current ( $V_{CE} = \text{Rated } V_{CES}, V_{EB} = 0$ )<br>( $T_C = 125^\circ\text{C}$ )<br>( $V_{CE} = 500\text{ V}, V_{EB} = 0$ ) ( $T_C = 125^\circ\text{C}$ ) | $I_{CES}$      | —   | — | 100 | $\mu\text{Adc}$ |
|   |                | —   | — | 500 |                 |
|   |                | —   | — | 100 |                 |
| Emitter Cutoff Current ( $V_{EB} = 9.0\text{ Vdc}, I_C = 0$ )   | $I_{EBO}$      | —   | — | 100 | $\mu\text{Adc}$ |

(1) Pulse Test: Pulse Width = 5.0 ms, Duty Cycle  $\leq 10\%$ .

(2) Proper strike and creepage distance must be provided.

(continued)

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**Designer's Data for "Worst Case" Conditions** — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. SOA Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

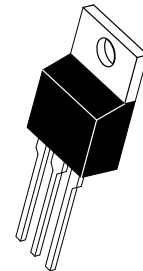
**Preferred** devices are Motorola recommended choices for future use and best overall value.

REV 1

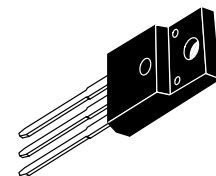
**BUL146\***  
**BUL146F\***

\*Motorola Preferred Device

**POWER TRANSISTOR**  
**6.0 AMPERES**  
**700 VOLTS**  
**40 and 100 WATTS**



**BUL146**  
**CASE 221A-06**  
**TO-220AB**



**BUL146F**  
**CASE 221D-02**  
**ISOLATED TO-220 TYPE**  
**UL RECOGNIZED**

# BUL146 BUL146F

## ELECTRICAL CHARACTERISTICS — continued (T<sub>C</sub> = 25°C unless otherwise noted)

| Characteristic   | Symbol               | Min                                     | Typ                                   | Max                              | Unit |
|--|----------------------|---|---------------------------------------|----------------------------------|------|
| <b>ON CHARACTERISTICS</b>  |                      |   |                                       |                                  |      |
| Base–Emitter Saturation Voltage (I <sub>C</sub> = 1.3 Adc, I <sub>B</sub> = 0.13 Adc)<br>(I <sub>C</sub> = 3.0 Adc, I <sub>B</sub> = 0.6 Adc)  | V <sub>BE(sat)</sub> | —<br>—                                  | 0.82<br>0.93                          | 1.1<br>1.25                      | Vdc  |
| Collector–Emitter Saturation Voltage (I <sub>C</sub> = 1.3 Adc, I <sub>B</sub> = 0.13 Adc)<br>(T <sub>C</sub> = 125°C)<br>(I <sub>C</sub> = 3.0 Adc, I <sub>B</sub> = 0.6 Adc)<br>(T <sub>C</sub> = 125°C)                                       | V <sub>CE(sat)</sub> | —<br>—<br>—                             | 0.22<br>0.20<br>0.30<br>0.30          | 0.5<br>0.5<br>0.7<br>0.7         | Vdc  |
| DC Current Gain (I <sub>C</sub> = 0.5 Adc, V <sub>CE</sub> = 5.0 Vdc)<br>(I <sub>C</sub> = 1.3 Adc, V <sub>CE</sub> = 1.0 Vdc)<br>(I <sub>C</sub> = 3.0 Adc, V <sub>CE</sub> = 1.0 Vdc)<br>(I <sub>C</sub> = 10 mAdc, V <sub>CE</sub> = 5.0 Vdc) | h <sub>FE</sub>      | 14<br>—<br>12<br>12<br>8.0<br>7.0<br>10 | —<br>30<br>20<br>20<br>13<br>12<br>20 | 34<br>—<br>—<br>—<br>—<br>—<br>— | —    |

## DYNAMIC CHARACTERISTICS

|  |   |                                 |        |             |        |   |
|--|---|---------------------------------|--------|-------------|--------|---|
| Current Gain Bandwidth (I <sub>C</sub> = 0.5 Adc, V <sub>CE</sub> = 10 Vdc, f = 1.0 MHz)   | f <sub>T</sub>  | —                               | 14     | —           | MHz    |   |
| Output Capacitance (V <sub>CB</sub> = 10 Vdc, I <sub>E</sub> = 0, f = 1.0 MHz)   | C <sub>OB</sub>   | —                               | 95     | 150         | pF     |   |
| Input Capacitance (V <sub>EB</sub> = 8.0 V)  | C <sub>IB</sub>   | —                               | 1000   | 1500        | pF     |   |
| Dynamic Saturation Voltage:<br>Determined 1.0 μs and<br>3.0 μs respectively after<br>rising I <sub>B1</sub> reaches 90% of<br>final I <sub>B1</sub><br>(see Figure 18) | (I <sub>C</sub> = 1.3 Adc<br>I <sub>B1</sub> = 300 mAdc<br>V <sub>CC</sub> = 300 V) | 1.0 μs (T <sub>C</sub> = 125°C) | —<br>— | 2.5<br>6.5  | —<br>— | V |
|  |   | 3.0 μs (T <sub>C</sub> = 125°C) | —<br>— | 0.6<br>2.5  | —<br>— |   |
|  | (I <sub>C</sub> = 3.0 Adc<br>I <sub>B1</sub> = 0.6 Adc<br>V <sub>CC</sub> = 300 V)  | 1.0 μs (T <sub>C</sub> = 125°C) | —<br>— | 3.0<br>7.0  | —<br>— |   |
|  |   | 3.0 μs (T <sub>C</sub> = 125°C) | —<br>— | 0.75<br>1.4 | —<br>— |   |

## SWITCHING CHARACTERISTICS: Resistive Load (D.C. ≤ 10%, Pulse Width = 20 μs)

|               |   |                  |        |              |          |    |
|---------------|---|------------------|--------|--------------|----------|----|
| Turn–On Time  | (I <sub>C</sub> = 1.3 Adc, I <sub>B1</sub> = 0.13 Adc<br>I <sub>B2</sub> = 0.65 Adc, V <sub>CC</sub> = 300 V)<br>(T <sub>C</sub> = 125°C) | t <sub>on</sub>  | —<br>— | 100<br>90    | 200<br>— | ns |
| Turn–Off Time |   | t <sub>off</sub> | —<br>— | 1.35<br>1.90 | 2.5<br>— | μs |
| Turn–On Time  | (I <sub>C</sub> = 3.0 Adc, I <sub>B1</sub> = 0.6 Adc<br>I <sub>B1</sub> = 1.5 Adc, V <sub>CC</sub> = 300 V)<br>(T <sub>C</sub> = 125°C)   | t <sub>on</sub>  | —<br>— | 90<br>100    | 150<br>— | ns |
| Turn–Off Time |   | t <sub>off</sub> | —<br>— | 1.7<br>2.1   | 2.5<br>— | μs |

## SWITCHING CHARACTERISTICS: Inductive Load (V<sub>clamp</sub> = 300 V, V<sub>CC</sub> = 15 V, L = 200 μH)

|                |  |                 |          |              |          |    |
|----------------|--|-----------------|----------|--------------|----------|----|
| Fall Time      | (I <sub>C</sub> = 1.3 Adc, I <sub>B1</sub> = 0.13 Adc<br>I <sub>B2</sub> = 0.65 Adc)<br>(T <sub>C</sub> = 125°C) | t <sub>fi</sub> | —<br>—   | 115<br>120   | 200<br>— | ns |
| Storage Time   |  | t <sub>si</sub> | —<br>—   | 1.35<br>1.75 | 2.5<br>— | μs |
| Crossover Time |  | t <sub>c</sub>  | —<br>—   | 200<br>210   | 350<br>— | ns |
| Fall Time      | (I <sub>C</sub> = 3.0 Adc, I <sub>B1</sub> = 0.6 Adc<br>I <sub>B2</sub> = 1.5 Adc)<br>(T <sub>C</sub> = 125°C)   | t <sub>fi</sub> | —<br>—   | 85<br>100    | 150<br>— | ns |
| Storage Time   |  | t <sub>si</sub> | —<br>—   | 1.75<br>2.25 | 2.5<br>— | μs |
| Crossover Time |  | t <sub>c</sub>  | —<br>—   | 175<br>200   | 300<br>— | ns |
| Fall Time      | (I <sub>C</sub> = 3.0 Adc, I <sub>B1</sub> = 0.6 Adc<br>I <sub>B2</sub> = 0.6 Adc)<br>(T <sub>C</sub> = 125°C)   | t <sub>fi</sub> | 80<br>—  | —<br>210     | 180<br>— | ns |
| Storage Time   |  | t <sub>si</sub> | 2.6<br>— | —<br>4.5     | 3.8<br>— | μs |
| Crossover Time |  | t <sub>c</sub>  | —<br>—   | 230<br>400   | 350<br>— | ns |

TYPICAL STATIC CHARACTERISTICS

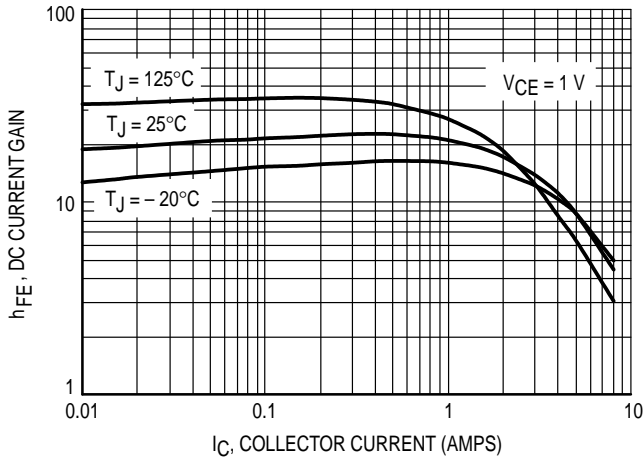


Figure 1. DC Current Gain @ 1 Volt

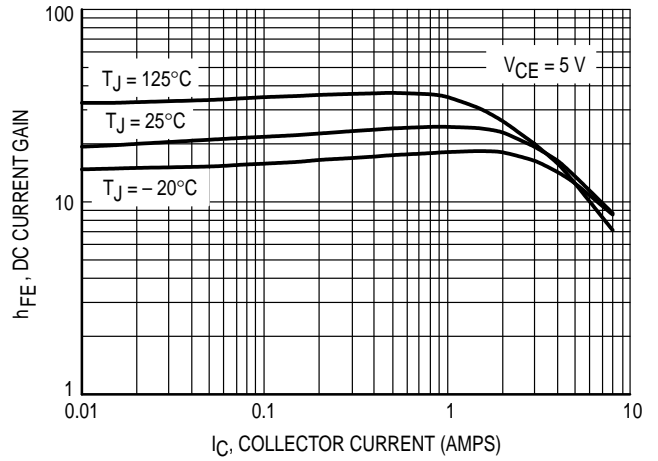


Figure 2. DC Current Gain @ 5 Volts

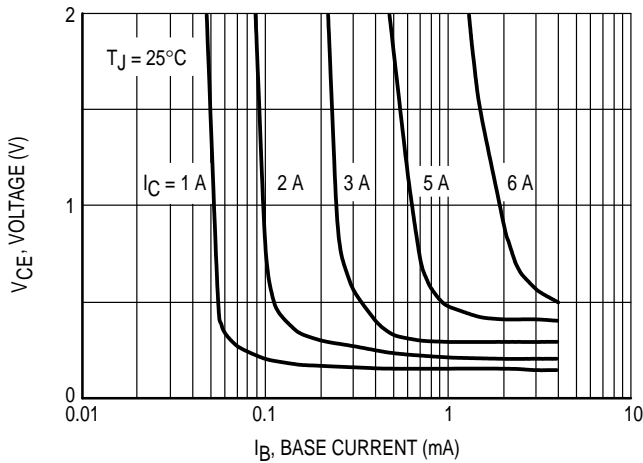


Figure 3. Collector Saturation Region

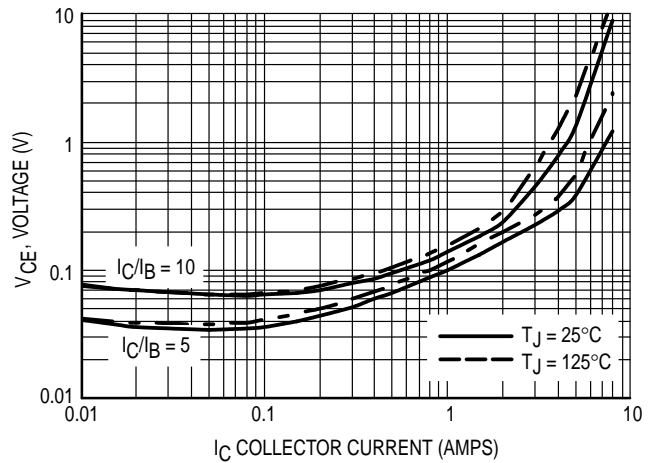


Figure 4. Collector-Emitter Saturation Voltage

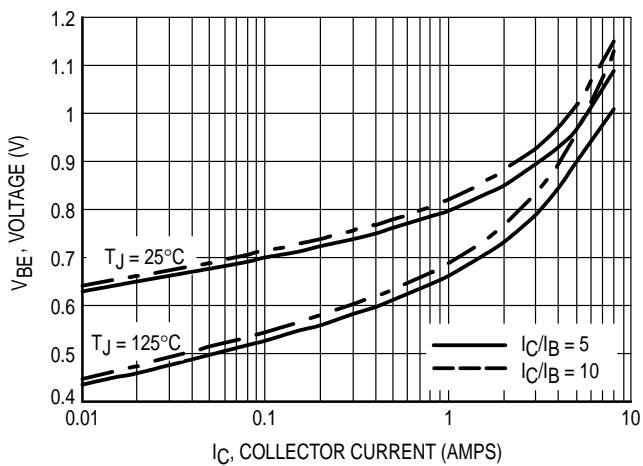


Figure 5. Base-Emitter Saturation Region

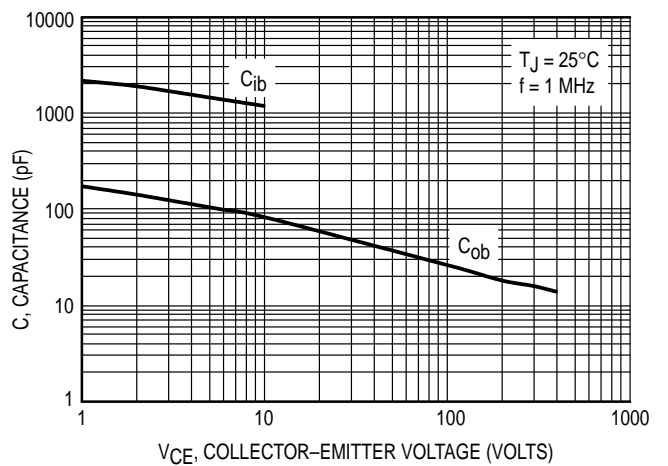


Figure 6. Capacitance

TYPICAL SWITCHING CHARACTERISTICS  
( $I_{B2} = I_C/2$  for all switching)

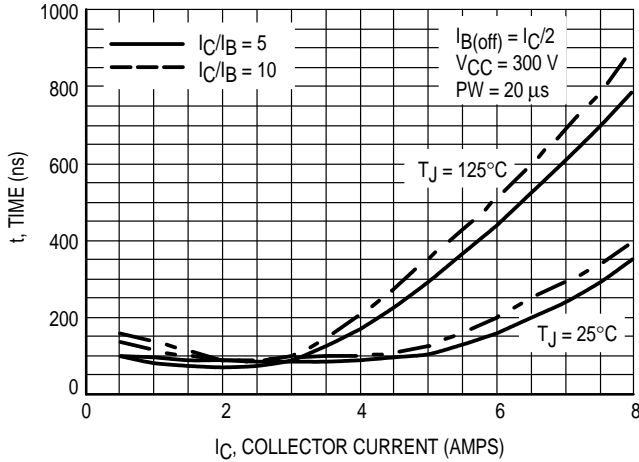


Figure 7. Resistive Switching,  $t_{on}$

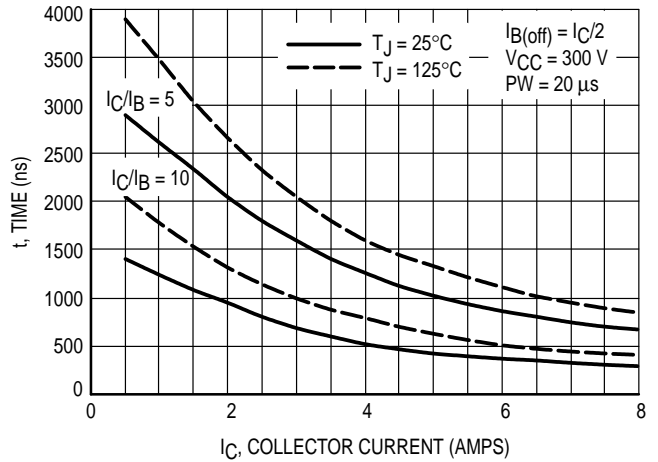


Figure 8. Resistive Switching,  $t_{off}$

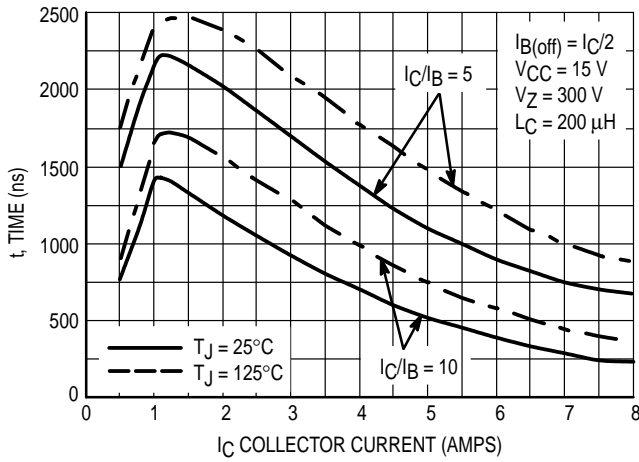


Figure 9. Inductive Storage Time,  $t_{sj}$

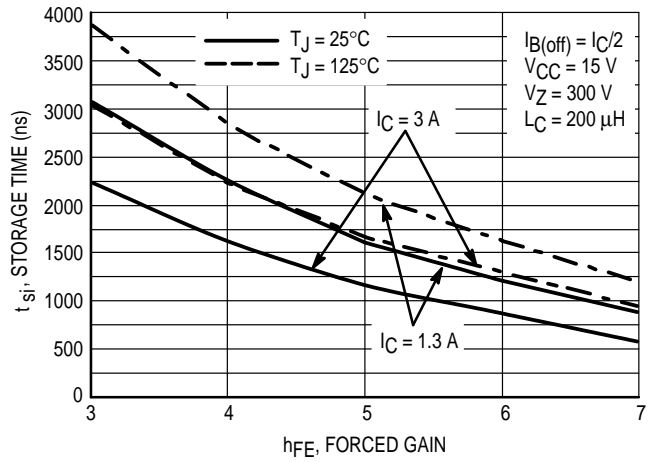


Figure 10. Inductive Storage Time,  $t_{sj}(h_{FE})$

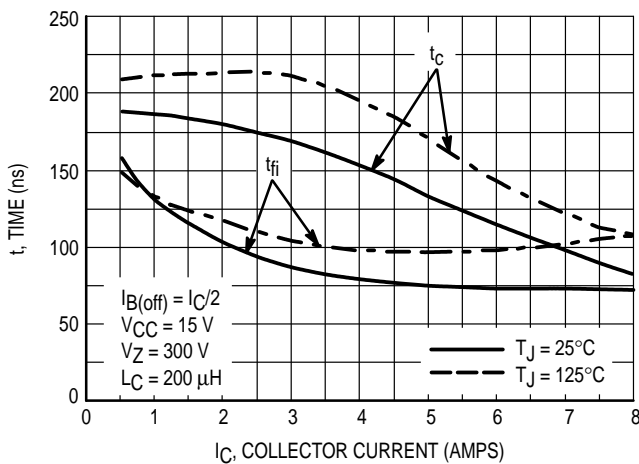


Figure 11. Inductive Switching,  $t_c$  and  $t_{fj}$   
 $I_C/I_B = 5$

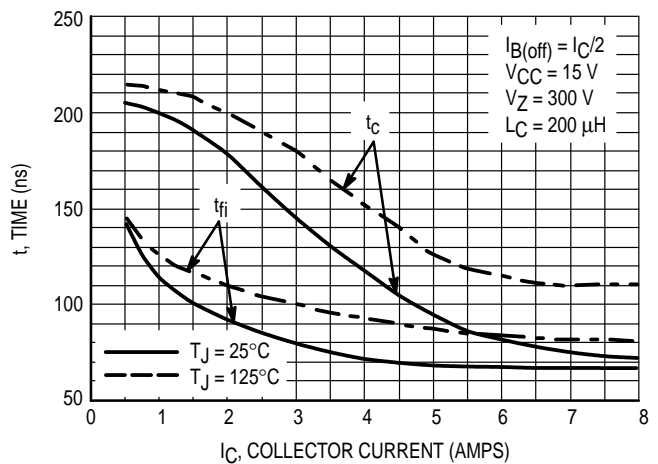


Figure 12. Inductive Switching,  $t_c$  and  $t_{fj}$   
 $I_C/I_B = 10$

TYPICAL SWITCHING CHARACTERISTICS  
( $I_{B2} = I_C/2$  for all switching)

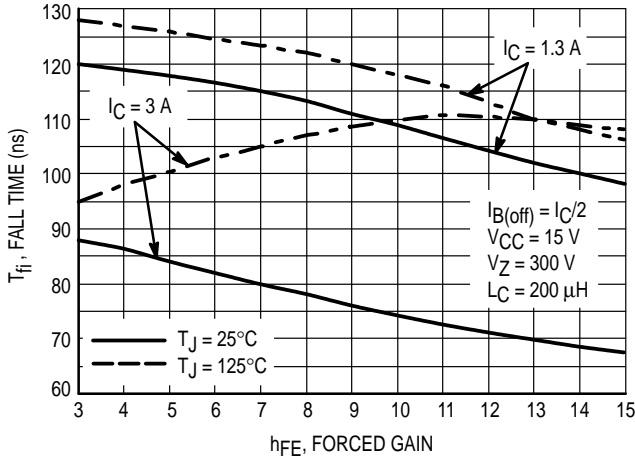


Figure 13. Inductive Fall Time

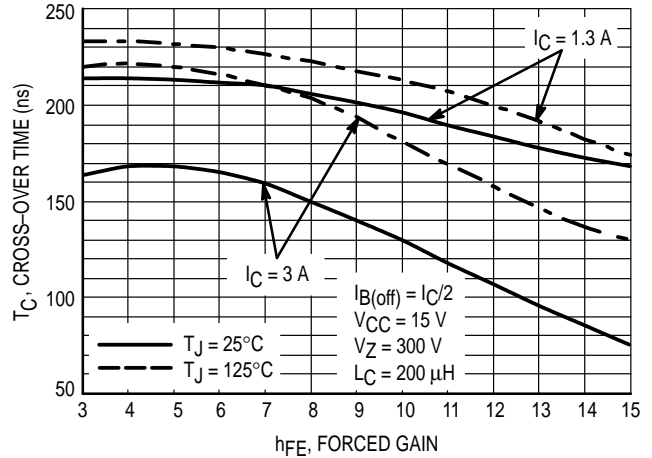


Figure 14. Inductive Cross-Over Time

GUARANTEED SAFE OPERATING AREA INFORMATION

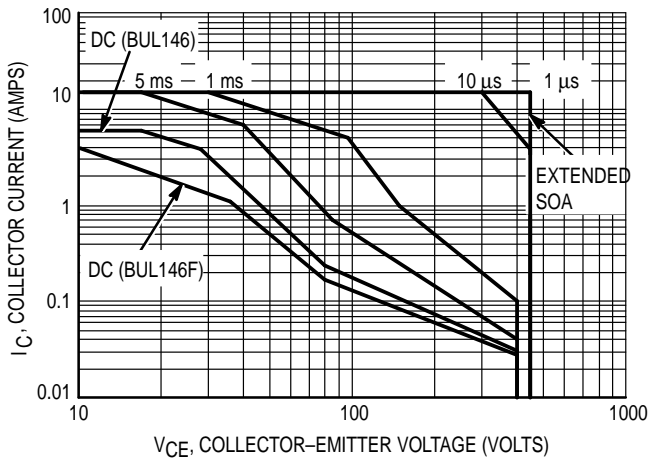


Figure 15. Forward Bias Safe Operating Area

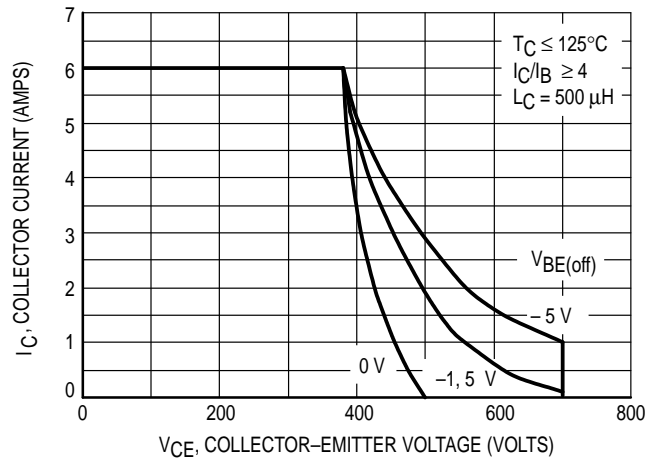


Figure 16. Reverse Bias Switching Safe Operating Area

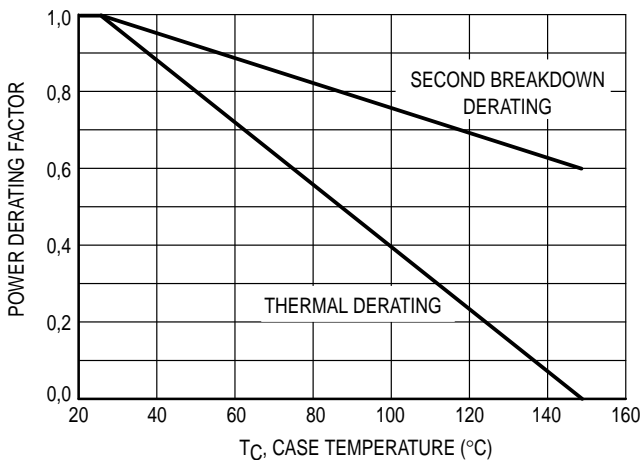
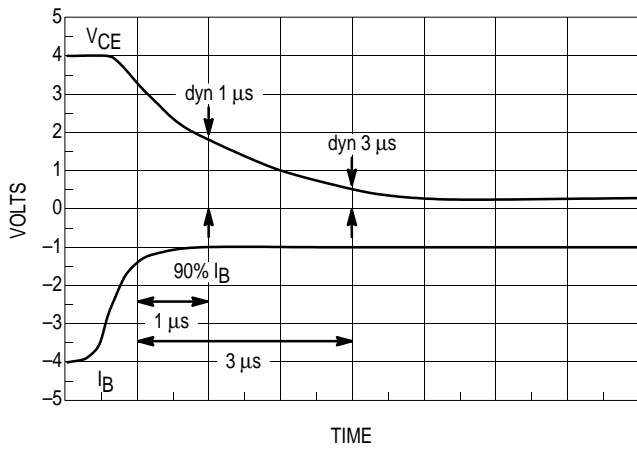
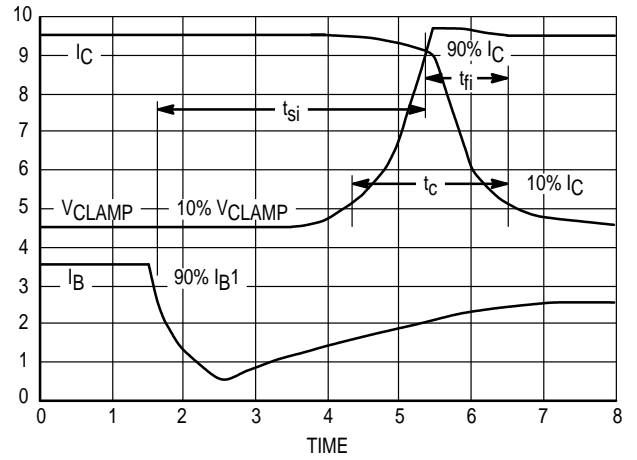


Figure 17. Forward Bias Power Derating

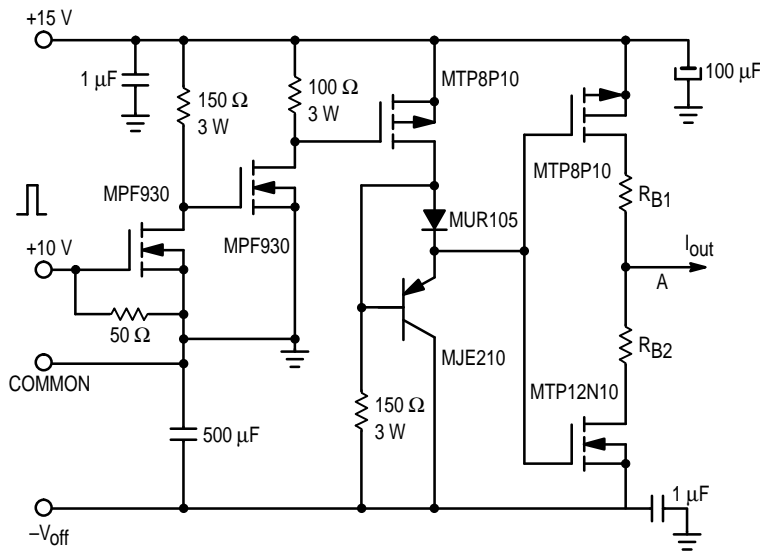
There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate  $I_C - V_{CE}$  limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate. The data of Figure 15 is based on  $T_C = 25^\circ\text{C}$ ;  $T_{J(pk)}$  is variable depending on power level. Second breakdown pulse limits are valid for duty cycles to 10% but must be derated when  $T_C > 25^\circ\text{C}$ . Second breakdown limitations do not derate the same as thermal limitations. Allowable current at the voltages shown in Figure 15 may be found at any case temperature by using the appropriate curve on Figure 17.  $T_{J(pk)}$  may be calculated from the data in Figure 20 and 21. At any case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown. For inductive loads, high voltage and current must be sustained simultaneously during turn-off with the base-to-emitter junction reverse-biased. The safe level is specified as a reverse-biased safe operating area (Figure 16). This rating is verified under clamped conditions so that the device is never subjected to an avalanche mode.



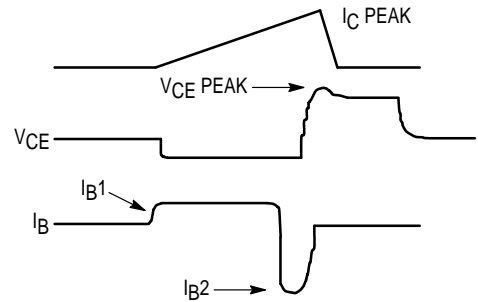
**Figure 18. Dynamic Saturation Voltage Measurements**



**Figure 19. Inductive Switching Measurements**



**Table 1. Inductive Load Switching Drive Circuit**



| <b>V(BR)CEO(sus)</b> | <b>INDUCTIVE SWITCHING</b>   | <b>RBSOA</b>                 |
|----------------------|------------------------------|------------------------------|
| L = 10 mH            | L = 200 μH                   | L = 500 μH                   |
| RB2 = ∞              | RB2 = 0                      | RB2 = 0                      |
| VCC = 20 VOLTS       | VCC = 15 VOLTS               | VCC = 15 VOLTS               |
| IC(pk) = 100 mA      | RB1 SELECTED FOR DESIRED IB1 | RB1 SELECTED FOR DESIRED IB1 |

TYPICAL THERMAL RESPONSE

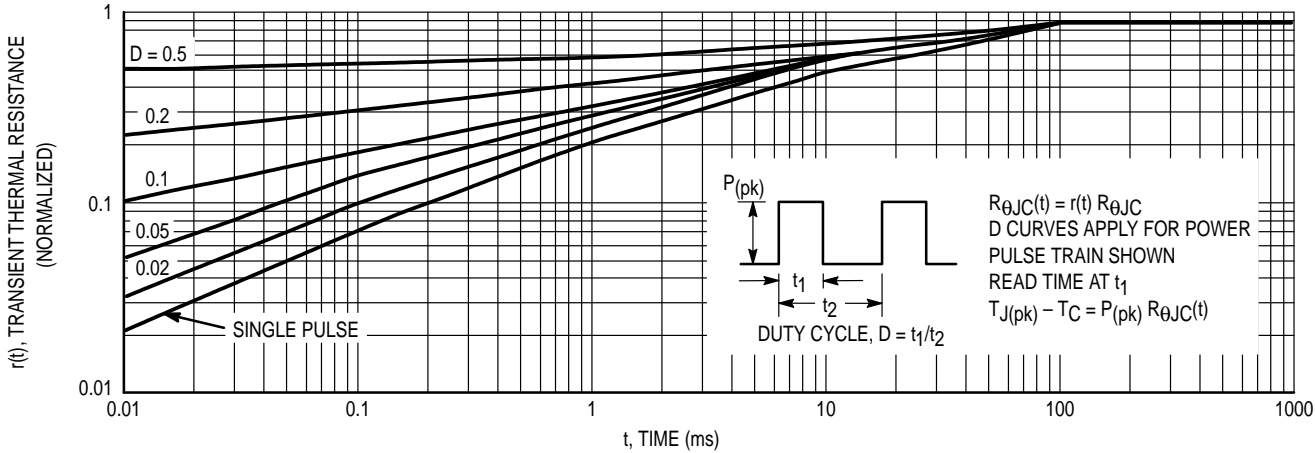


Figure 20. Typical Thermal Response ( $Z_{\theta JC}(t)$ ) for BUL146

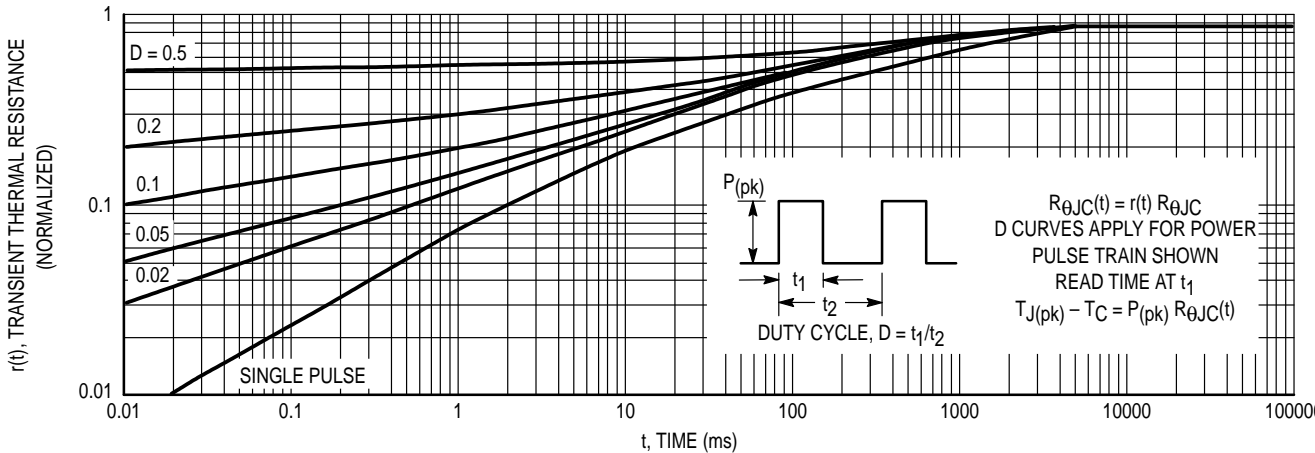
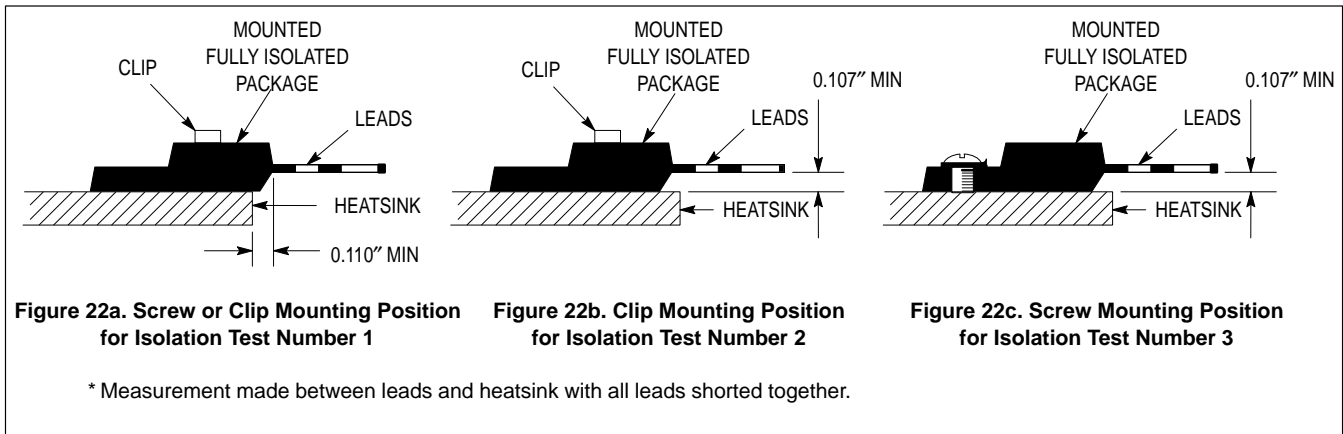
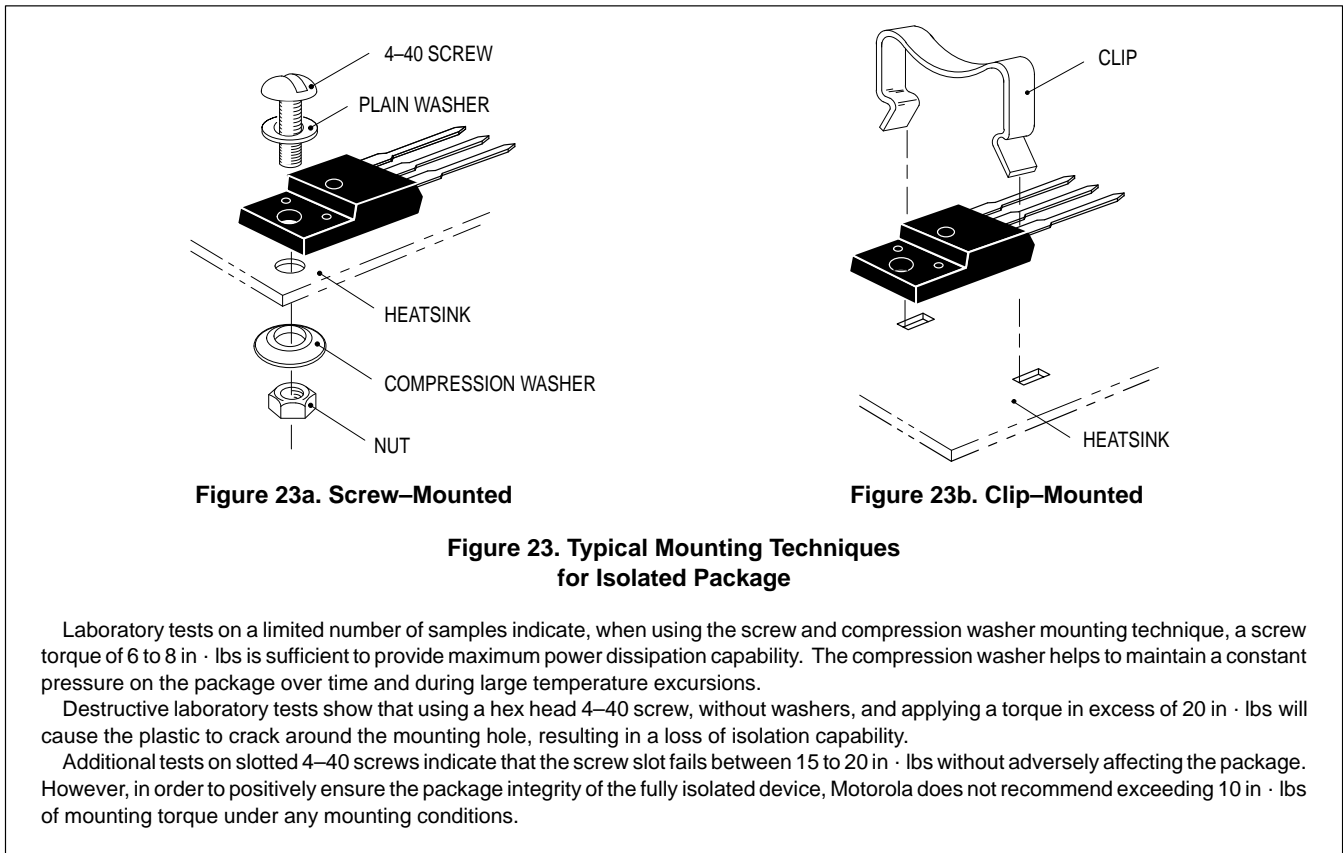


Figure 21. Typical Thermal Response ( $Z_{\theta JC}(t)$ ) for BUL146F

TEST CONDITIONS FOR ISOLATION TESTS\*



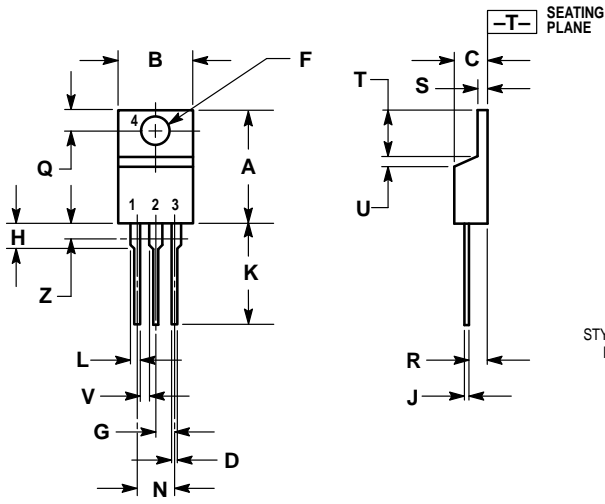
MOUNTING INFORMATION\*\*



\*\* For more information about mounting power semiconductors see Application Note AN1040.



PACKAGE DIMENSIONS

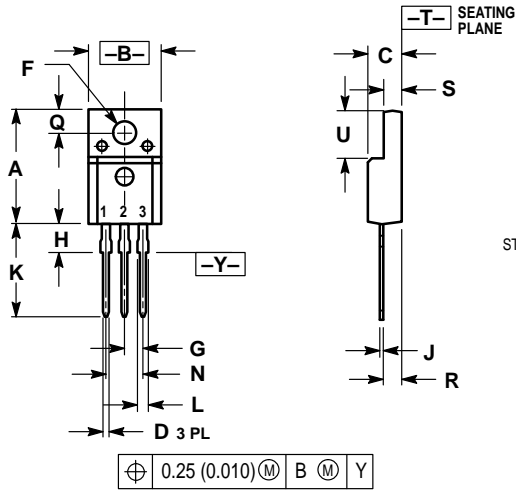


- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
  3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

| DIM | INCHES |       | MILLIMETERS |       |
|-----|--------|-------|-------------|-------|
|     | MIN    | MAX   | MIN         | MAX   |
| A   | 0.570  | 0.620 | 14.48       | 15.75 |
| B   | 0.380  | 0.405 | 9.66        | 10.28 |
| C   | 0.160  | 0.190 | 4.07        | 4.82  |
| D   | 0.025  | 0.035 | 0.64        | 0.88  |
| F   | 0.142  | 0.147 | 3.61        | 3.73  |
| G   | 0.095  | 0.105 | 2.42        | 2.66  |
| H   | 0.110  | 0.155 | 2.80        | 3.93  |
| J   | 0.018  | 0.025 | 0.46        | 0.64  |
| K   | 0.500  | 0.562 | 12.70       | 14.27 |
| L   | 0.045  | 0.060 | 1.15        | 1.52  |
| N   | 0.190  | 0.210 | 4.83        | 5.33  |
| Q   | 0.100  | 0.120 | 2.54        | 3.04  |
| R   | 0.080  | 0.110 | 2.04        | 2.79  |
| S   | 0.045  | 0.055 | 1.15        | 1.39  |
| T   | 0.235  | 0.255 | 5.97        | 6.47  |
| U   | 0.000  | 0.050 | 0.00        | 1.27  |
| V   | 0.045  | —     | 1.15        | —     |
| Z   | —      | 0.080 | —           | 2.04  |

- STYLE 1:  
 PIN 1. BASE  
 2. COLLECTOR  
 3. EMITTER  
 4. COLLECTOR

**BUL44**  
**CASE 221A-06**  
**TO-220AB**  
**ISSUE Y**




- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.

| DIM | INCHES    |       | MILLIMETERS |       |
|-----|-----------|-------|-------------|-------|
|     | MIN       | MAX   | MIN         | MAX   |
| A   | 0.621     | 0.629 | 15.78       | 15.97 |
| B   | 0.394     | 0.402 | 10.01       | 10.21 |
| C   | 0.181     | 0.189 | 4.60        | 4.80  |
| D   | 0.026     | 0.034 | 0.67        | 0.86  |
| F   | 0.121     | 0.129 | 3.08        | 3.27  |
| G   | 0.100 BSC | —     | 2.54 BSC    | —     |
| H   | 0.123     | 0.129 | 3.13        | 3.27  |
| J   | 0.018     | 0.025 | 0.46        | 0.64  |
| K   | 0.500     | 0.562 | 12.70       | 14.27 |
| L   | 0.045     | 0.060 | 1.14        | 1.52  |
| N   | 0.200 BSC | —     | 5.08 BSC    | —     |
| Q   | 0.126     | 0.134 | 3.21        | 3.40  |
| R   | 0.107     | 0.111 | 2.72        | 2.81  |
| S   | 0.096     | 0.104 | 2.44        | 2.64  |
| U   | 0.259     | 0.267 | 6.58        | 6.78  |

- STYLE 2:  
 PIN 1. BASE  
 2. COLLECTOR  
 3. EMITTER

**BUL44F**  
**CASE 221D-02**  
**(ISOLATED TO-220 TYPE)**  
**ISSUE D**

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